

# XN0611FH (XN611FH)

Silicon PNP epitaxial planer transistor

For switching/digital circuits

### ■ Features

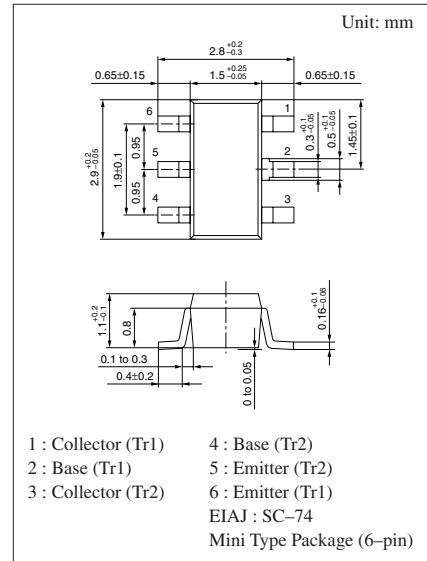
- Two elements incorporated into one package.  
(Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

### ■ Basic Part Number of Element

- UNR111F(UN111F) + UNR111H(UN111H)

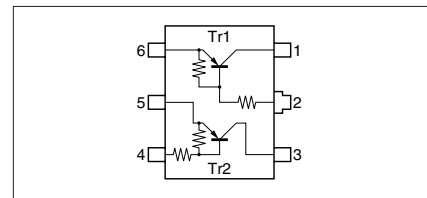
### ■ Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rated	Unit
Tr1	Collector to base voltage	$V_{CBO}$	-50	V
	Collector to emitter voltage	$V_{CEO}$	-50	V
	Collector current	$I_C$	-100	mA
Tr2	Collector to base voltage	$V_{CBO}$	-50	V
	Collector to emitter voltage	$V_{CEO}$	-50	V
	Collector current	$I_C$	-100	mA
Overall	Total power dissipation	$P_T$	300	mW
	Junction temperature	$T_j$	150	°C
	Storage temperature	$T_{stg}$	-55 to +150	°C



Marking Symbol: 4S

Internal Connection



Note.) The Part number in the Parenthesis shows conventional part number.

### ■ Electrical Characteristics (T<sub>a</sub>=25°C)

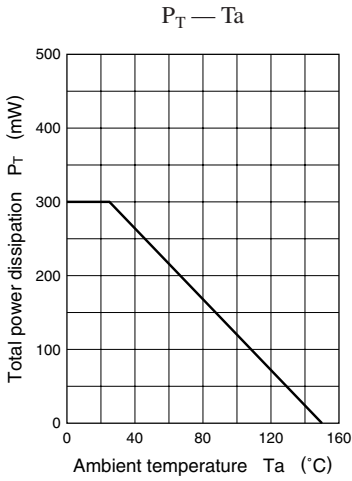
#### ● Tr1

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	I <sub>C</sub> = -10μA, I <sub>E</sub> = 0	-50			V
Collector to emitter voltage	V <sub>CEO</sub>	I <sub>C</sub> = -2mA, I <sub>B</sub> = 0	-50			V
Collector cutoff current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0			-0.1	μA
	I <sub>CEO</sub>	V <sub>CE</sub> = -50V, I <sub>B</sub> = 0			-0.5	μA
Emitter cutoff current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V, I <sub>C</sub> = 0			-1.0	mA
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = -10V, I <sub>C</sub> = -5mA	30			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -10mA, I <sub>B</sub> = -0.3mA			-0.25	V
Output voltage high level	V <sub>OH</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -0.5V, R <sub>L</sub> = 1kΩ	-4.9			V
Output voltage low level	V <sub>OL</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -2.5V, R <sub>L</sub> = 1kΩ			-0.2	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 1mA, f = 200MHz		80		MHz
Input resistance	R <sub>1</sub>		-30%	4.7	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>			0.47		

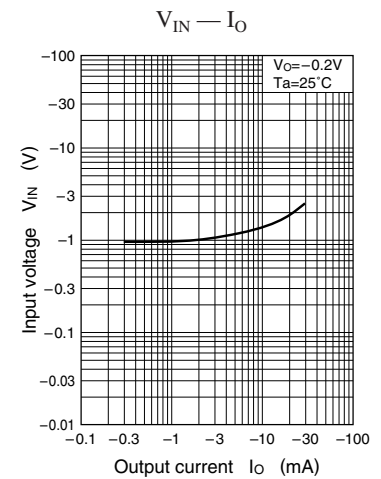
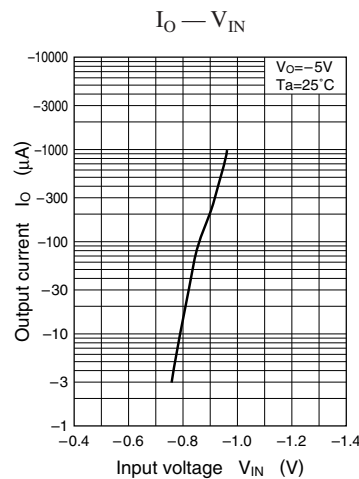
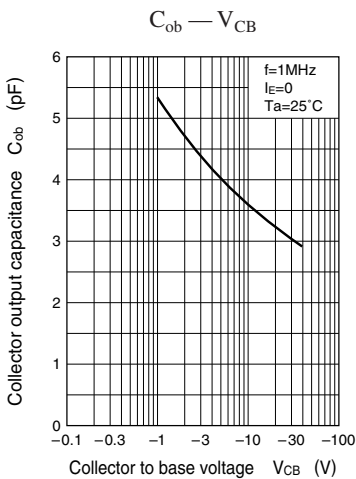
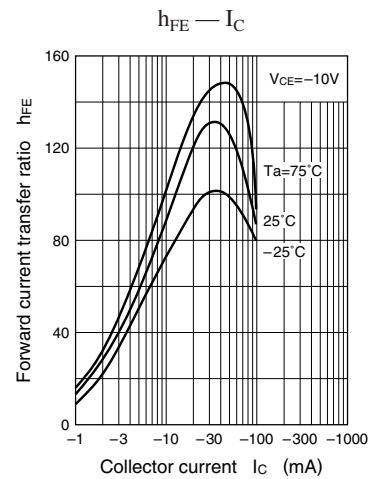
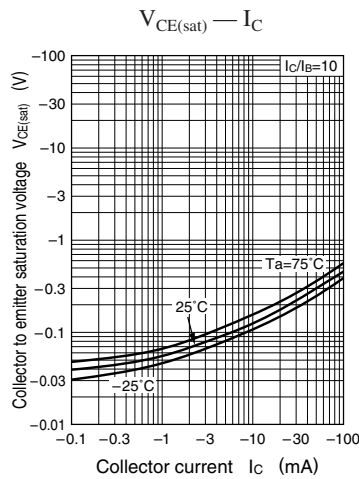
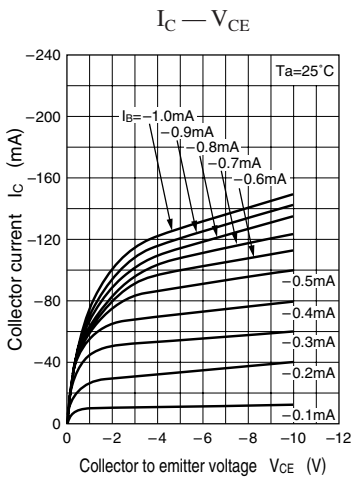
#### ● Tr2

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	I <sub>C</sub> = -10μA, I <sub>E</sub> = 0	-50			V
Collector to emitter voltage	V <sub>CEO</sub>	I <sub>C</sub> = -2mA, I <sub>B</sub> = 0	-50			V
Collector cutoff current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0			-0.1	μA
	I <sub>CEO</sub>	V <sub>CE</sub> = -50V, I <sub>B</sub> = 0			-0.5	μA
Emitter cutoff current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V, I <sub>C</sub> = 0			-0.5	mA
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = -10V, I <sub>C</sub> = -5mA	30			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -10mA, I <sub>B</sub> = -0.3mA			-0.25	V
Output voltage high level	V <sub>OH</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -0.5V, R <sub>L</sub> = 1kΩ	-4.9			V
Output voltage low level	V <sub>OL</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -2.5V, R <sub>L</sub> = 1kΩ			-0.2	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 1mA, f = 200MHz		80		MHz
Input resistance	R <sub>1</sub>		-30%	2.2	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.17	0.22	0.27	

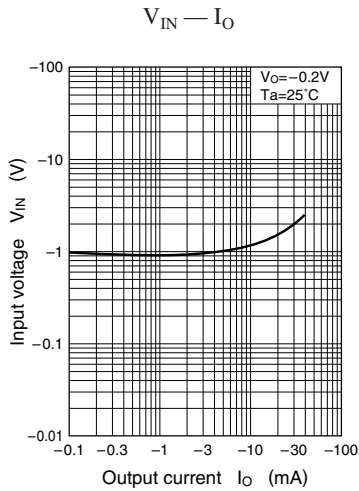
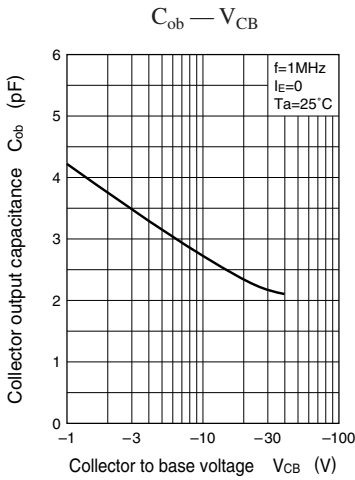
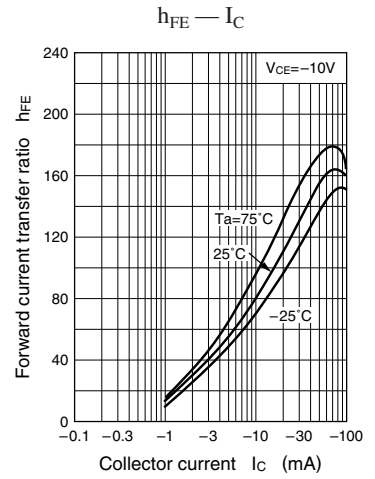
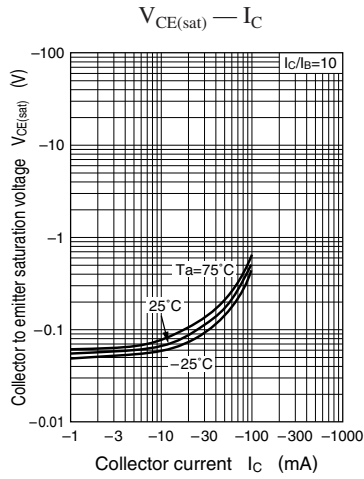
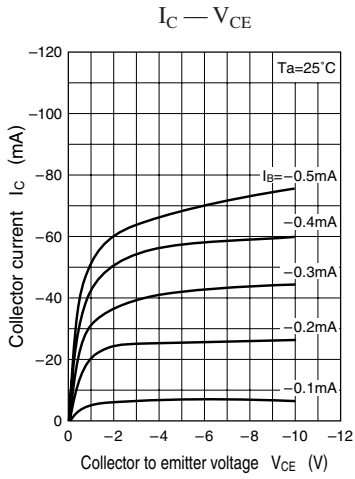
Common characteristics chart



Characteristics charts of Tr1



Characteristics charts of Tr2



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